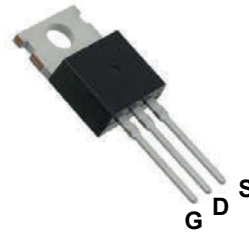
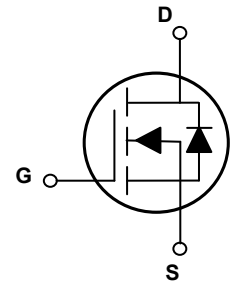


## Main Product Characteristics

|               |                      |
|---------------|----------------------|
| $V_{(BR)DSS}$ | 600V                 |
| $R_{DS(ON)}$  | 0.19 $\Omega$ (Max.) |
| $I_D$         | 20A                  |



TO-220



Schematic Diagram

## Features and Benefits

- Advanced MOSFET process technology
- Ideal for high efficiency switched mode power supplies
- Low on-resistance with low gate charge
- Fast switching and reverse body recovery



## Description

The GSFH60R190 utilizes the latest techniques to achieve high cell density and low on-resistance. These features make this device extremely efficient and reliable for use in high efficiency switch mode power supplies and a wide variety of other applications.

## Absolute Maximum Ratings (T<sub>C</sub>=25°C unless otherwise specified)

| Parameter  | Symbol                           | Rating      | Unit |
|--|----------------------------------|-------------|------|
| Drain-Source Voltage   | $V_{DS}$                         | 600         | V    |
| Gate-to-Source Voltage   | $V_{GS}$                         | $\pm 30$    | V    |
| Continuous Drain Current, @ Steady-State (T <sub>C</sub> =25°C)  | $I_D$                            | 20          | A    |
| Continuous Drain Current, @ Steady-State (T <sub>C</sub> =100°C) |                                  | 12          | A    |
| Pulsed Drain Current   | $I_{DM}$                         | 80          | A    |
| Power Dissipation (T <sub>C</sub> =25°C)                         | $P_D$                            | 66          | W    |
|  |                                  | 0.52        | W/°C |
| Single Pulse Avalanche Energy <sup>1</sup>                       | $E_{AS}$                         | 967         | mJ   |
| Body Diode Reverse Voltage Slope <sup>2</sup>                    | dv/dt                            | 15          | V/ns |
| MOS dv/dt Ruggedness <sup>3</sup>                                | dv/dt                            | 50          | V/ns |
| Junction-to-Ambient (PCB Mounted, Steady-State)                  | $R_{\theta JA}$                  | 62.5        | °C/W |
| Junction-to-Case   | $R_{\theta JC}$                  | 1.90        | °C/W |
| Operating Junction and Storage Temperature Range                 | T <sub>J</sub> /T <sub>STG</sub> | -55 to +150 | °C   |

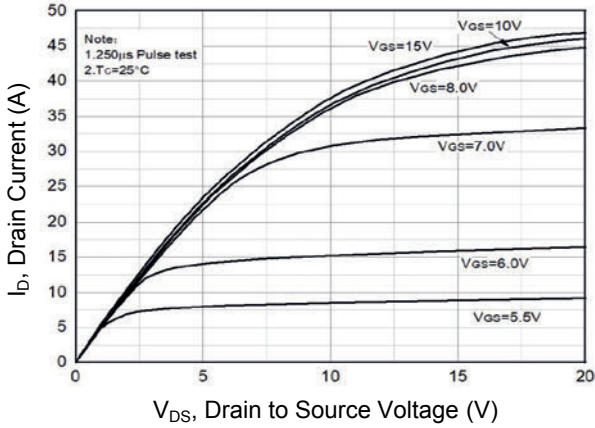
**Electrical Characteristics** ( $T_C=25^\circ\text{C}$  unless otherwise specified)

| Parameter                                       | Symbol        | Conditions  | Min. | Typ. | Max. | Unit          |
|---|---------------|---|------|------|------|---------------|
| <b>On / Off Characteristics</b>                 |               |   |      |      |      |               |
| Drain-to-Source Breakdown Voltage               | $V_{(BR)DSS}$ | $V_{GS}=0V, I_D=250\mu A$   | 600  | -    | -    | V             |
| Drain-to-Source Leakage Current                 | $I_{DSS}$     | $V_{DS}=600V, V_{GS}=0V$  | -    | -    | 200  | nA            |
| Gate-to-Source Forward Leakage                  | $I_{GSS}$     | $V_{DS}=0V, V_{GS}=30V$   | -    | -    | 100  | nA            |
|   |               | $V_{DS}=0V, V_{GS}=-30V$  | -    | -    | -100 |               |
| Static Drain-to-Source On-Resistance            | $R_{DS(ON)}$  | $V_{GS}=10V, I_D=10A, T_J=25^\circ\text{C}$   | -    | 0.16 | 0.19 | $\Omega$      |
|   |               | $V_{GS}=10V, I_D=10A, T_J=125^\circ\text{C}$  | -    | 0.3  | -    | $\Omega$      |
| Gate Threshold Voltage                          | $V_{GS(th)}$  | $V_{DS}=V_{GS}, I_D=250\mu A$   | 2.0  | -    | 4.0  | V             |
| <b>Dynamic and Switching Characteristics</b>    |               |   |      |      |      |               |
| Input Capacitance                               | $C_{ISS}$     | $V_{GS}=0V, V_{DS}=100V, F=1\text{MHz}$   | -    | 1174 | -    | pF            |
| Output Capacitance                              | $C_{OSS}$     |   | -    | 67   | -    |               |
| Reverse Transfer Capacitance                    | $C_{RSS}$     |   | -    | 4.0  | -    |               |
| Total Gate Charge <sup>4,5</sup>                | $Q_g$         | $I_D=20A, V_{DD}=480V, V_{GS}=10V$  | -    | 39   | -    | nC            |
| Gate-to-Source Charge <sup>4,5</sup>            | $Q_{gs}$      |   | -    | 9.6  | -    |               |
| Gate-to-Drain ("Miller") Charge <sup>4,5</sup>  | $Q_{gd}$      |   | -    | 20   | -    |               |
| Turn-On Delay Time <sup>4,5</sup>               | $t_{d(on)}$   | $V_{DD}=300V, V_{GS}=10V, R_G=25\Omega, I_D=20A$  | -    | 20   | -    | nS            |
| Rise Time <sup>4,5</sup>                        | $t_r$         |   | -    | 60   | -    |               |
| Turn-Off Delay Time <sup>4,5</sup>              | $t_{d(off)}$  |   | -    | 105  | -    |               |
| Fall Time <sup>4,5</sup>                        | $t_f$         |   | -    | 42   | -    |               |
| Gate Resistance                                 | $R_g$         | $F=1\text{MHz}$   | -    | 2.6  | -    | $\Omega$      |
| <b>Source-Drain Ratings and Characteristics</b> |               |   |      |      |      |               |
| Continuous Source Current (Body Diode)          | $I_S$         | $T_C=25^\circ\text{C}$ , MOSFET symbol showing the integral reverse p-n junction diode. | -    | -    | 20   | A             |
| Source Pulse Current                            | $I_{SM}$      |   | -    | -    | 80   | A             |
| Diode Forward Voltage                           | $V_{SD}$      | $I_S=20A, V_{GS}=0V$  | -    | -    | 1.2  | V             |
| Reverse Recovery Time <sup>3</sup>              | $T_{rr}$      | $I_F=20A, V_{DD}=50V, di_F/dt=100A/\mu s$   | -    | 426  | -    | nS            |
| Reverse Recovery Charge <sup>3</sup>            | $Q_{rr}$      |   | -    | 6.2  | -    | $\mu\text{C}$ |

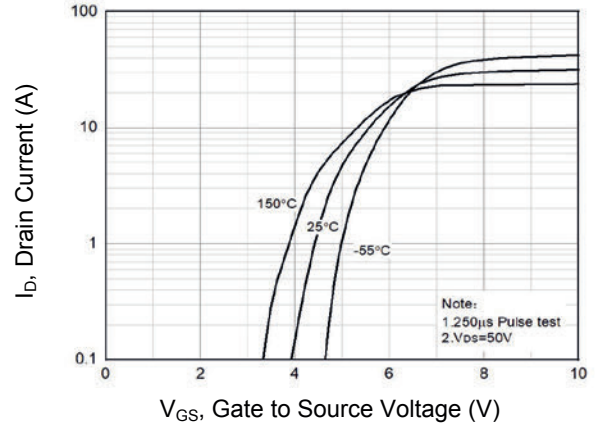
Note:

1.  $L=79\text{mH}, I_{AS}=4.6A, V_{DD}=100V$ , starting temperature  $T_J=25^\circ\text{C}$ .
2.  $V_{DS}=0-400V, I_{SD}\leq 20A, T_J=25^\circ\text{C}$ .
3.  $V_{DS}=0-480V$ .
4. Pulse test: Pulse width  $\leq 300\mu s$ , duty cycle  $\leq 2\%$ .
5. Essentially independent of operating temperature.

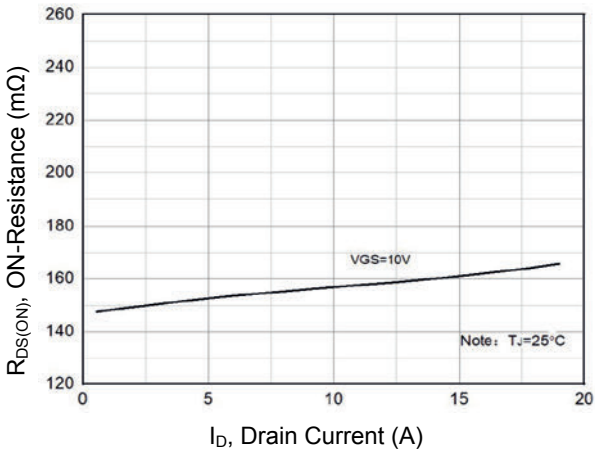
**Typical Electrical and Thermal Characteristic Curves**



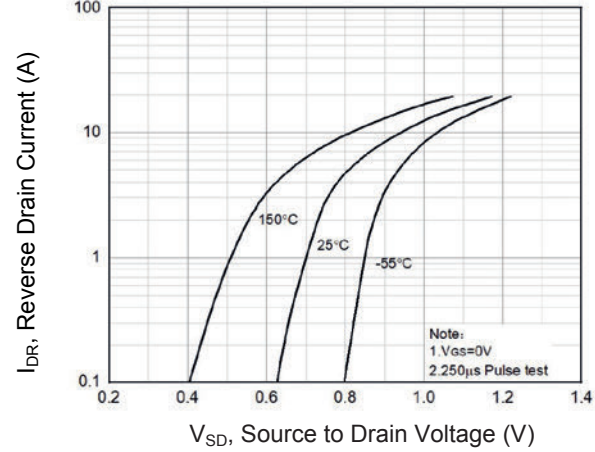
**Figure 1. Typical Output Characteristics**



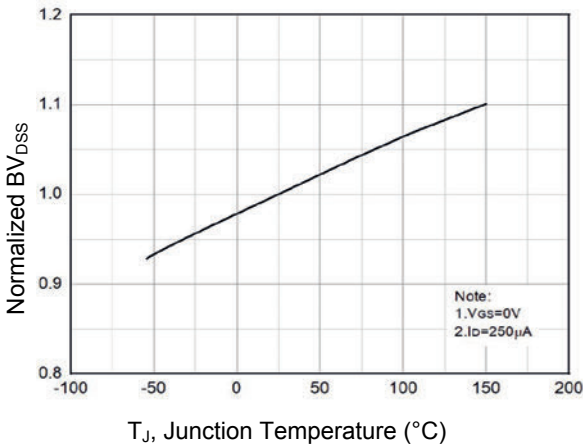
**Figure 2. Transfer Characteristics**



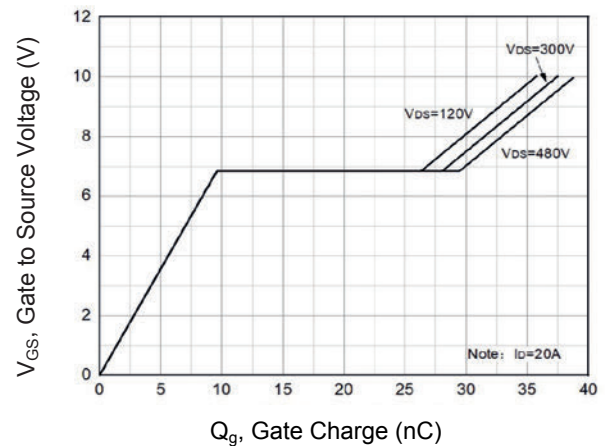
**Figure 3. On-Resistance vs. Drain Current**



**Figure 4. Body Diode Characteristics**

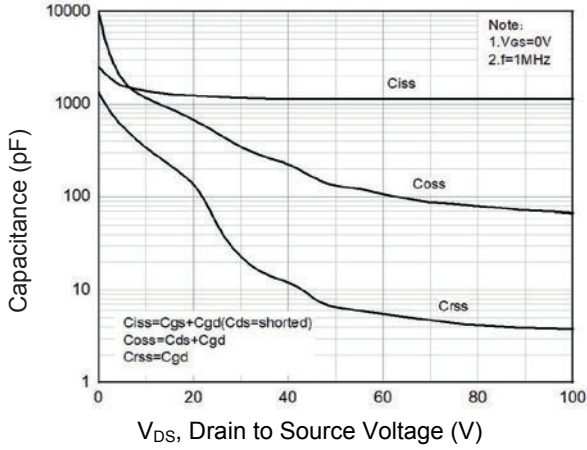


**Figure 5. Normalized  $BV_{DSS}$  vs.  $T_J$**

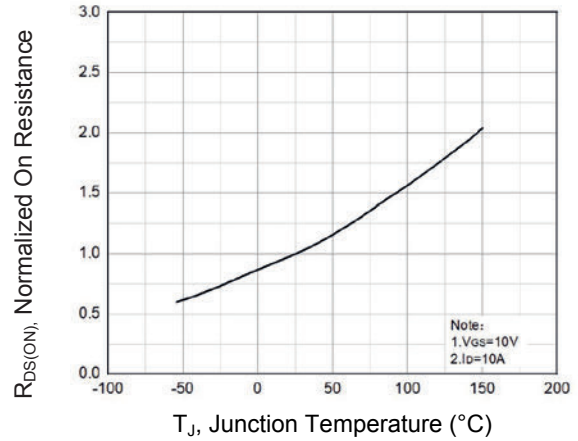


**Figure 6. Gate Charge**

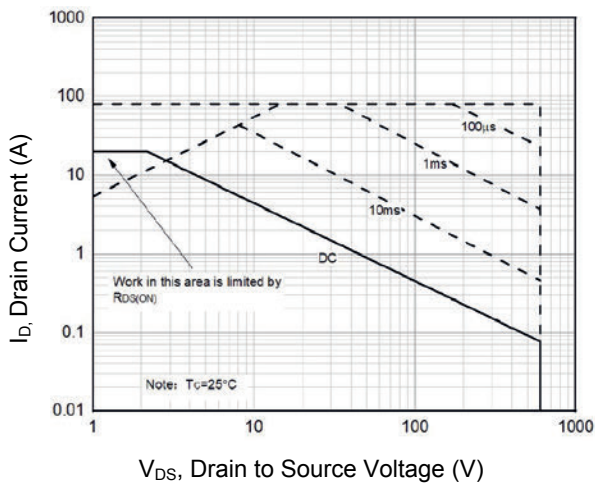
**Typical Electrical and Thermal Characteristic Curves**



**Figure 7. Capacitance Characteristics**

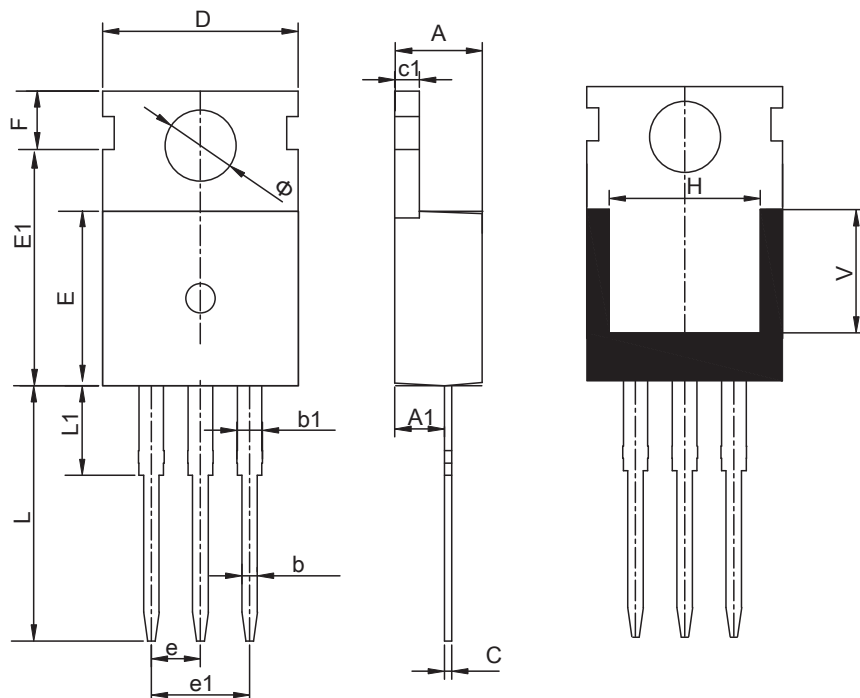


**Figure 8. Normalized On-Resistance vs.  $T_J$**



**Figure 9. Safe Operation Area**

## Package Outline Dimensions (TO-220)



| Symbol | Dimensions In Millimeters |       | Dimensions In Inches |       |
|--------|---------------------------|-------|----------------------|-------|
|        | Min.                      | Max.  | Min.                 | Max.  |
| A      | 4.40                      | 4.60  | 0.173                | 0.181 |
| A1     | 2.25                      | 2.70  | 0.089                | 0.106 |
| b      | 0.71                      | 0.91  | 0.028                | 0.036 |
| b1     | 1.17                      | 1.37  | 0.046                | 0.054 |
| C      | 0.33                      | 0.65  | 0.013                | 0.026 |
| c1     | 1.20                      | 1.40  | 0.047                | 0.055 |
| D      | 9.91                      | 10.25 | 0.390                | 0.404 |
| E      | 8.95                      | 9.75  | 0.352                | 0.384 |
| E1     | 12.65                     | 13.00 | 0.498                | 0.512 |
| e      | 2.54 TYP                  |       | 0.100 TYP            |       |
| e1     | 4.98                      | 5.18  | 0.196                | 0.204 |
| F      | 2.65                      | 2.95  | 0.104                | 0.116 |
| H      | 7.90                      | 8.10  | 0.311                | 0.319 |
| L      | 12.90                     | 13.40 | 0.508                | 0.528 |
| L1     | 2.68                      | 3.25  | 0.106                | 0.128 |
| V      | 6.90 REF                  |       | 0.272 REF            |       |
| Φ      | 3.40                      | 3.80  | 0.134                | 0.150 |

## Order Information

| Device     | Package | Marking | Carrier | Quantity     |
|------------|---------|---------|---------|--------------|
| GSFH60R190 | TO-220  | H60R190 | Tube    | 50pcs / Tube |

For more information, please contact us at: [inquiry@goodarksemi.com](mailto:inquiry@goodarksemi.com)